

SEMICONDUCTOR PHYSICS-RELATED EQUATIONS

$$x_{sc} = \sqrt{\frac{2\epsilon_{si}(N_a + N_d)}{q(N_a N_d)}(\phi_{bi} - V_a)} \quad (1)$$

$$\phi_{bi} = \frac{kT}{q} \ln \frac{N_a N_d}{n_i^2} \quad (2)$$

$$np = n_i^2 \quad (3)$$

$$\frac{D}{\mu} = \frac{kT}{q} \quad (4)$$

$$v = \mu E \quad (5)$$

$$n = n_i \exp\left(\frac{q(\phi_f - \phi_i)}{kT}\right) \quad (6)$$

$$p = p_i \exp\left(\frac{q(\phi_i - \phi_f)}{kT}\right) \quad (7)$$

$$J_n = -q\mu n \nabla \phi_{fn} \quad (8)$$

$$J_p = -q\mu p \nabla \phi_{fp} \quad (9)$$

$$J_n = q[n\mu_n E_x + D_n \frac{dn}{dx}] \quad (10)$$

$$J = env \quad (11)$$

$$\rho = \frac{1}{en\mu} \quad (12)$$

$$\sigma = \frac{1}{\rho} \quad (13)$$

$$R = \rho G \quad (14)$$

$$G = \frac{L}{A} \quad (15)$$

$$\rho^{sheet} = \frac{\rho}{t} \quad (16)$$

$$E_x = -\frac{\partial \phi}{\partial x} \quad (17)$$

$$E_{sheet} = \frac{1}{2} \frac{\sigma}{\epsilon_{si}} \quad (18)$$

$$f(E) = \frac{1}{1 + \exp[(E - E_f)/kT]} \quad (19)$$

For trap occupancy including spin degeneracy:

$$f(E) = \frac{1}{1 + g \exp[(E - E_f)/kT]} \quad (20)$$

DIODE RELATED EQUATIONS

$$I_D = I_s \left(\exp\left(\frac{qV_d}{kT}\right) - 1 \right) \quad (21)$$

$$C_{sc} = \frac{\partial Q_{sc}}{\partial V_a} = \frac{A\epsilon_{si}}{x_{sc}} \quad (22)$$

$$C_{diff} = \frac{\tau I_D}{V_{thermal}} \quad (23)$$

$$J_s = \frac{qD_p p_{no}}{L_p} + \frac{qD_n n_{po}}{L_n} \quad (24)$$

MOSCAPS

$$C_{ox} = A \frac{\epsilon_{ox}}{d_{ox}} \quad (25)$$

Semiconductor space-charge capacitance:

$$C_{sc} = A \frac{\epsilon_{si}}{x_{sc}} \quad (26)$$

Flat-band capacitance:

$$C_{FB} = A \frac{\epsilon_{si}}{L_d} \quad (27)$$

$$L_d = \sqrt{\frac{2\epsilon_{si}}{qN_{doping}} \frac{kT}{q}} \quad (28)$$

MOS-RELATED EQUATIONS

$$\phi_b = \frac{kT}{q} \ln \left[\frac{N_{a,d}}{n_i} \right] \quad (29)$$

$$V_{th}^0 = 2\phi_b + \frac{1}{C_{ox}} \sqrt{2qN_a\epsilon_{si}2\phi_b} \quad (30)$$

$$V_{th} = V_{FB} + V_{th}^0 \quad (31)$$

$$I_{ds}^{L/T} = \mu C_{ox} \frac{W}{L} \left((V_{gs} - V_{th})V_{ds} - \frac{V_{ds}^2}{2} \right) \quad (32)$$

$$I_{ds}^{sat} = \frac{\mu C_{ox}}{2} \frac{W}{L} ((V_{gs} - V_{th})^2) (1 + \lambda V_{ds}) \quad (33)$$

$$\Delta V_{th} = \gamma [\sqrt{2\phi_b - V_{sx}} - \sqrt{2\phi_b}] \quad (34)$$

$$r_o = \frac{V_a}{I_c} \quad (35)$$

$$g_m = \frac{2I_{ds}}{V_{gs} - V_{th}} \quad (36)$$

$$V_{gs} - V_{th} = V_{ds}^{po} \quad (37)$$

PROCESS RELATED EQUATIONS

$$d_{min} = 1.25\sqrt{g\lambda} \quad (38)$$

$$x_{min} = k_1 \frac{\lambda}{NA} \quad (39)$$

$$DOF = k_2 \frac{\lambda}{NA^2} \quad (40)$$

For Oxidation:

$$x = \frac{B}{A}(t + \tau) \quad (41)$$

$$x = \sqrt{Bt} \quad (42)$$

For Implant:

$$C(x) = C_p \exp\left[-\frac{(x - R_p)^2}{2\Delta R_p^2}\right] \quad (43)$$

For Diffusions;

$$C_{dep}(x, t) = C_s \operatorname{erfc}\left(-\frac{x}{2\sqrt{Dt}}\right) \quad (44)$$

$$C_{drive}(x, t) = \frac{N'}{\sqrt{\pi Dt}} \exp\left(-\frac{x^2}{4Dt}\right) \quad (45)$$

An estimate of the diffused junction depth;

$$x_d = \sqrt{Dt} \quad (46)$$

CONSTANTS

$$\epsilon_{si} = 10^{-12} Fd - cm^{-1} \quad (47)$$

$$\epsilon_{ox} = 3.5 \times 10^{-13} Fd - cm^{-1} \quad (48)$$

$$\mu_n = 1500 cm^2/V - s \quad (49)$$

$$\mu_p = 500 cm^2/V - s \quad (50)$$

$$V_{thermal} = 0.0259V \quad (51)$$

$$q = 1.6 \times 10^{-19} Coulombs \quad (52)$$

Typically, you may take: $\tau = 10^{-4} sec$, $L_n = L_p = 10^{-3} cm$